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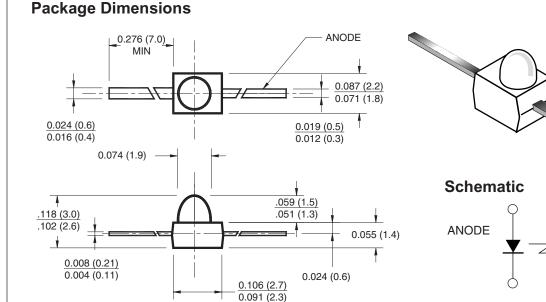
September 2006



# QEB363 Subminiature Plastic Infrared Emitting Diode

### Features

- T-3/4 (2mm) Surface Mount Package
- Tape & Reel Option (See Tape & Reel Specifications)
- Lead Form Options: Gullwing, Yoke, Z-Bend
- Narrow Emission Angle, 24°
- Wavelength = 940nm, GaAs
- Clear Water Lens
- Matched Photosensor: QSB363
- High Radiant Intensity



### Notes:

- 1. Dimensions are in inches (mm).
- 2. Tolerance of ±.010 (.25) on all non nominal dimensions unless otherwise specified.

Symbol	Parameter	Rating	Unit
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
T <sub>STG</sub>	Storage Temperature	-40 to +100	°C
T <sub>SOL-I</sub>	Soldering Temperature (Iron) <sup>(2,3,4)</sup>	240 for 5 sec	°C
T <sub>SOL-F</sub>	Soldering Temperature (Flow) <sup>(2,3)</sup>	260 for 10 sec	°C
١ <sub>F</sub>	Continuous Forward Current	50	mA
V <sub>R</sub>	Reverse Voltage	5	V
PD	Power Dissipation <sup>(1)</sup>	100	mW

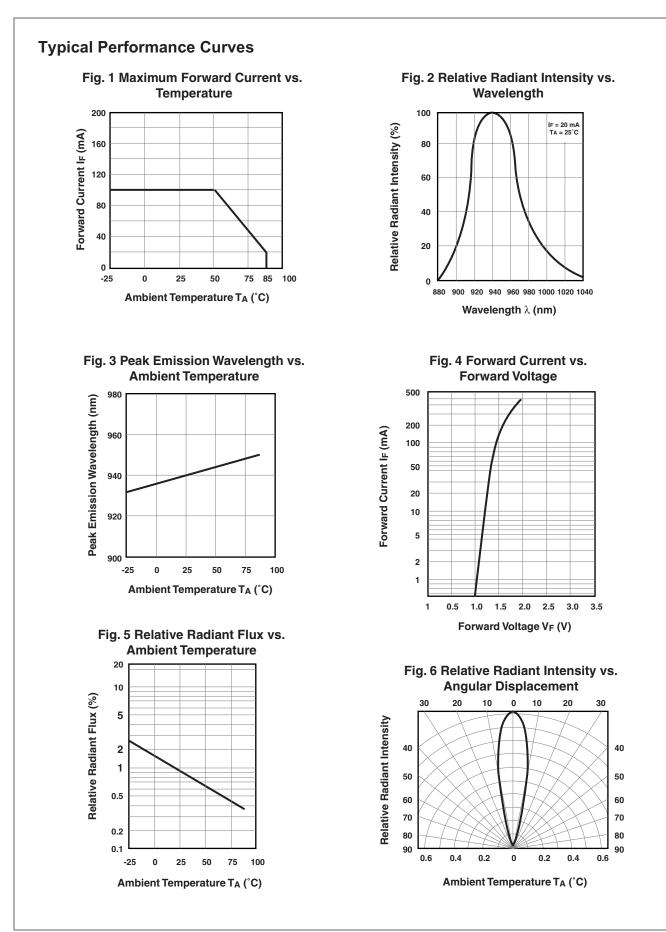
### Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise specified)

### Notes:

- 1. Derate power dissipation linearly 1.33mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6mm) minimum from housing.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
λ <sub>P</sub>	Peak Emission Wavelength	I <sub>F</sub> = 100mA		940		nm
Θ	Emission Angle	I <sub>F</sub> = 100mA		±12		0
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 100mA, t <sub>p</sub> = 20ms			1.6	V
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 5V			100	μA
Ι <sub>e</sub>	Radiant Intensity	I <sub>F</sub> = 100mA, tp = 20ms	8			mW/sr
t <sub>r</sub>	Rise Time	I <sub>F</sub> = 100mA		1		μs
t <sub>f</sub>	Fall Time	t <sub>p</sub> = 20ms		1		μs

### **Electrical/Optical Characteristics** (T<sub>A</sub> = 25°C)

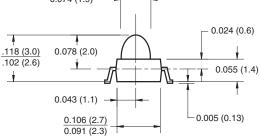


### Surface Mount Options for T-3/4 Package

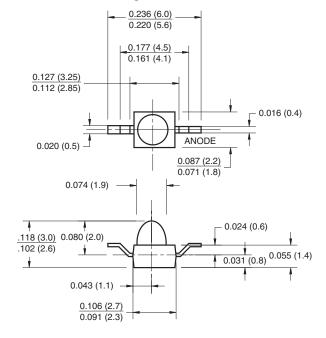
### Features

- Three lead forming options: Gull Wing, Yoke and Z-Bend
- Compatible with automatic placement equipment
- Supplied on tape and reel or in bulk packaging
- Compatible with vapor phase reflow solder processes

# Gull Wing Lead Configuration



### Z-Bend Lead Configuration

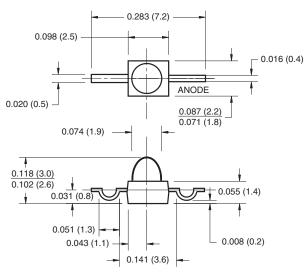


Notes: (Applies to all package drawings)

1. Dimensions are in inches (mm).

2. Tolerance of ±.010 (.25) on all non nominal dimensions unless otherwise specified.

### Yoke Lead Configuration



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QEB363 Subminiature Plastic Infrared Emitting Diode

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